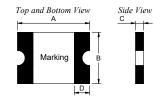
1, Physical Dimensions(size of 0805)

Unit:mm

Dout Namehou	A		В		С		D	Moulting	
Part Number	Min	Max	Min	Max	Min	Max	Min	Marking	
K0805L075/16AR	2.0	2.3	1.2	1.5	0.60	1.00	0.20	5	



2. Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I max (A)	Ttrij (Max time Current(A)		Pd _{typ} (W)	$R_{min} (\Omega)$	$R1_{max}$ (Ω)
K0805L075/16AR	0.75	1.50	16.0	100	8.0	0.20	0.60	0.09	0.42

I_H: Holding Current: maximum current at which the device will not trip in 25°C still air.

I_T: Tripping Current minimum current at which the device will trip in 25°C still air.

 V_{max} : Maximum voltage device can withstand without damage at rated current.

I max: Maximum fault current device can withstand without damage at rated voltage.

T trip: Maximum time to trip(s) at assigned current.

Pd_{typ}: Rated working power.

R min: Minimum resistance of device prior to trip at 25°C.

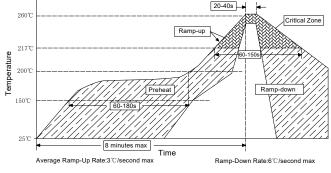
R1 max: Maximum resistance of device is measured one hours post reflow at 25°C.

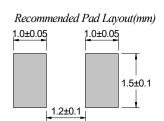
Noted: All electrical function test is conducted after PCB mounted.

3. Thermal Derating

K0805L075/16AR	Maximum ambient operating temperature									
	-40°C	-20°C	0℃	25℃	40°C	50°C	60°C	70°C	85℃	
Hold Current(A)	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.42	0.35	
Trip Current(A)	2.00	1.80	1.58	1.50	1.26	1.14	1.06	0.84	0.70	

4. Solder Reflow Recommendations





Notes:If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5. Package Information

Packing quantity:3500PCS/Reel

Note:Reel packaging per EIA-481-1 standard